



# 74LV165A-Q100

## 8-bit parallel-in/serial-out shift register

Rev. 4 — 18 April 2024

Product data sheet

### 1. General description

The 74LV165A-Q100 is an 8-bit parallel-load or serial-in shift register with complementary serial outputs (Q7 and  $\overline{Q7}$ ) available from the last stage. When the parallel-load input ( $\overline{PL}$ ) is LOW, parallel data from the inputs D0 to D7 are loaded into the register asynchronously. When input  $\overline{PL}$  is HIGH, data enters the register serially at the input DS. It shifts one place to the right (Q0 → Q1 → Q2, etc.) with each positive-going clock transition. This feature allows parallel-to-serial converter expansion by tying the output Q7 to the input DS of the succeeding stage. The clock input is a gate-OR structure which allows one input to be used as an active LOW clock enable input ( $\overline{CE}$ ) input. The pin assignment for the inputs CP and  $\overline{CE}$  is arbitrary and can be reversed for layout convenience. The LOW-to-HIGH transition of the input  $\overline{CE}$  should only take place while CP HIGH for predictable operation.

Schmitt-trigger action at all inputs, makes the circuit tolerant for slower input rise and fall times. It is fully specified for partial-power-down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing the damaging current backflow through the device when it is powered down.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 3) and is suitable for use in automotive applications.

### 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 3)
  - Specified from -40 °C to +85 °C
- Wide supply voltage range from 2.0 V to 5.5 V
- Synchronous parallel-to-serial applications
- Synchronous serial input for easy expansion
- Latch-up performance exceeds 250 mA
- CMOS LOW power consumption
- 5.5 V tolerant inputs/outputs
- Direct interface with TTL levels (2.7 V to 3.6 V)
- Power-down mode
- Complies with JEDEC standards:
  - JESD8-5 (2.3 V to 2.7 V)
  - JESD8B/JESD36 (2.7 V to 3.6 V)
  - JESD8-1A (4.5 V to 5.5 V)
- ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V

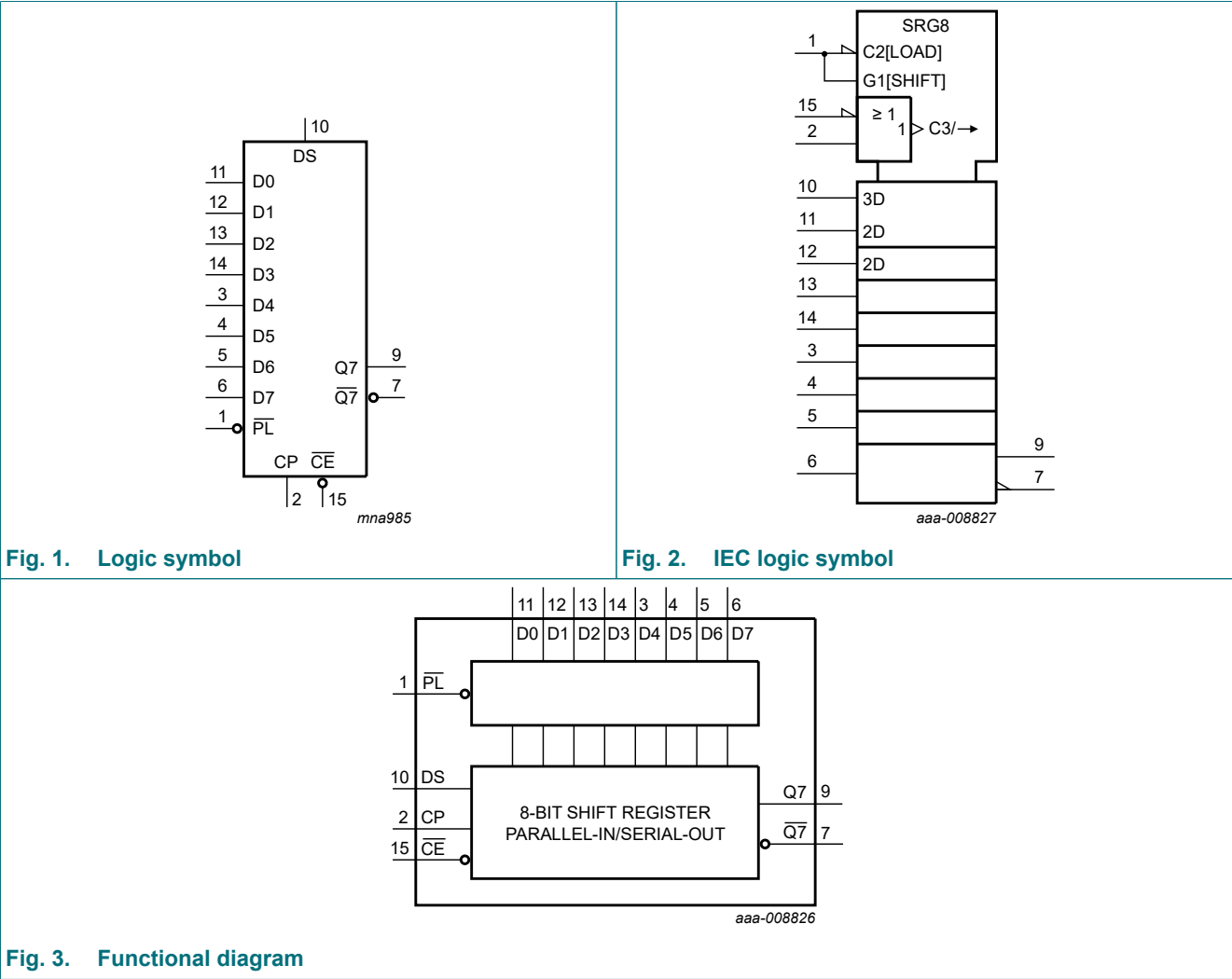
### 3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
<a href="#">74LV165AD-Q100</a>	-40 °C to +85 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	<a href="#">SOT109-1</a>

Type number	Package			
	Temperature range	Name	Description	Version
<a href="#">74LV165APW-Q100</a>	-40 °C to +85 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	<a href="#">SOT403-1</a>

4. Functional diagram



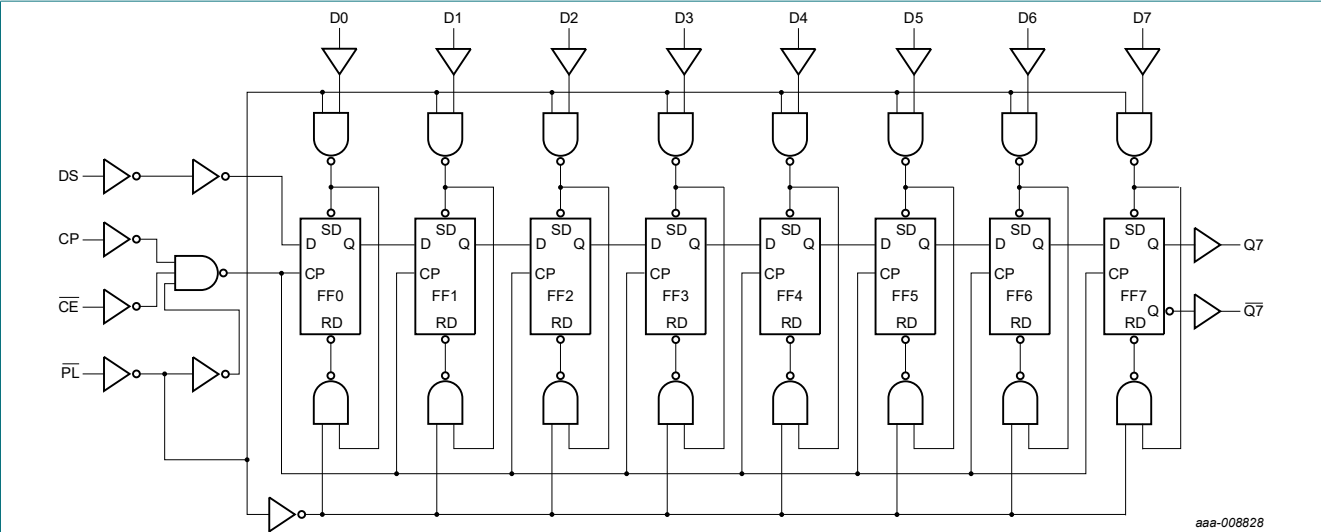
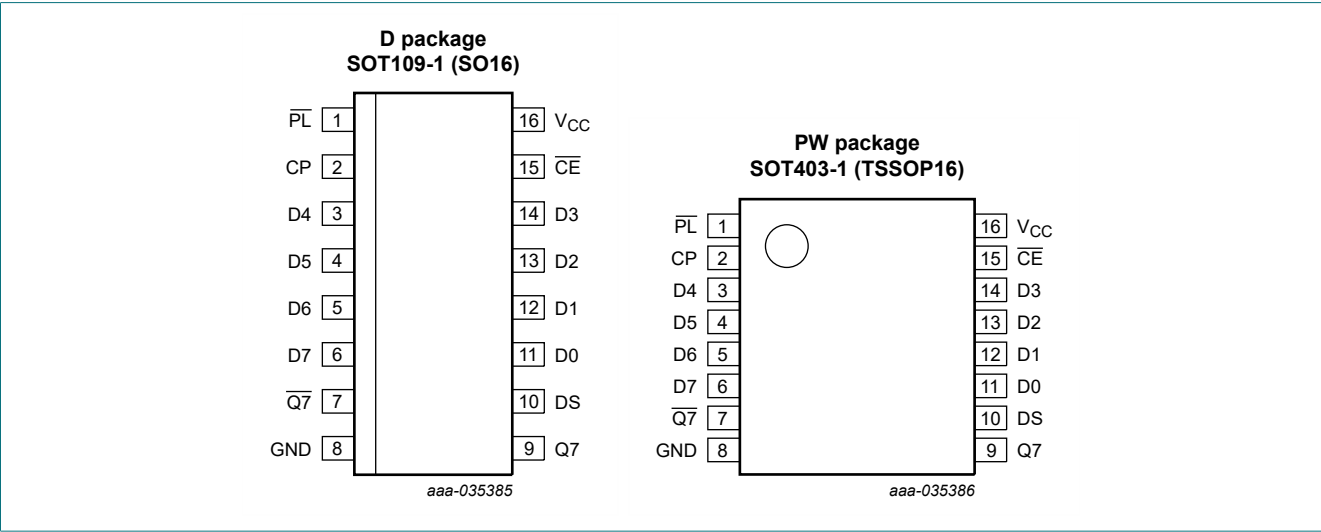


Fig. 4. Logic diagram

5. Pinning information

5.1. Pinning



5.2. Pin description

Table 2. Pin description

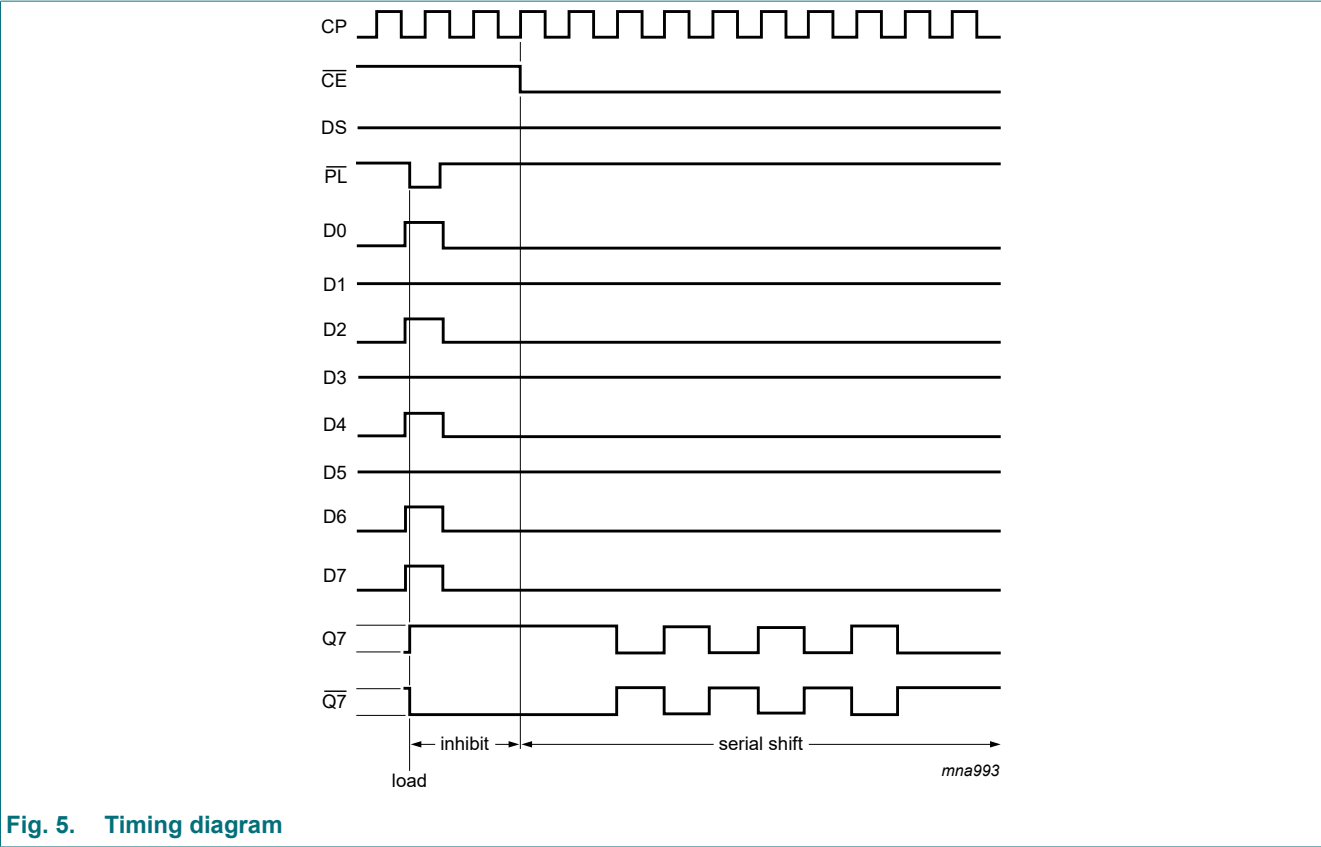
Symbol	Pin	Description
PL	1	parallel enable input (active LOW)
CP	2	clock input (LOW-to-HIGH edge-triggered)
$\overline{Q7}$	7	complementary serial output from the last stage
GND	8	ground (0 V)
Q7	9	serial output from the last stage
DS	10	serial data input
D0 to D7	11, 12, 13, 14, 3, 4, 5, 6	parallel data inputs
$\overline{CE}$	15	clock enable input (active LOW)
V <sub>CC</sub>	16	positive supply voltage

6. Functional description

Table 3. Function table

*H = HIGH voltage level; h = HIGH voltage level one set-up time prior to the LOW-to-HIGH clock transition;  
L = LOW voltage level; l = LOW voltage level one set-up time prior to the LOW-to-HIGH clock transition;  
q = state of the referenced output one set-up time prior to the LOW-to-HIGH clock transition;  
X = don't care; ↑ = LOW-to-HIGH clock transition.*

Operating modes	Inputs					Qn registers		Output	
	PL	$\overline{CE}$	CP	DS	D0 to D7	Q0	Q1 to Q6	Q7	$\overline{Q7}$
parallel load	L	X	X	X	L	L	L to L	L	H
	L	X	X	X	H	H	H to H	H	L
serial shift	H	L	↑	l	X	L	q0 to q5	q6	$\overline{q6}$
	H	L	↑	h	X	H	q0 to q5	q6	$\overline{q6}$
	H	↑	L	l	X	L	q0 to q5	q6	$\overline{q6}$
	H	↑	L	h	X	H	q0 to q5	q6	$\overline{q6}$
hold "do nothing"	H	H	X	X	X	q0	q1 to q6	q7	$\overline{q7}$
	H	X	H	X	X	q0	q1 to q6	q7	$\overline{q7}$



7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V) [1]

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+7	V
$I_{IK}$	input clamping current	$V_I < 0\text{ V}$	-	-20	mA
$V_I$	input voltage		-0.5	+7	V
$I_{OK}$	output clamping current	$V_O > V_{CC}$ or $V_O < 0$	-	$\pm 50$	mA
$V_O$	output voltage		-0.5	$V_{CC} + 0.5$	V
		power-down mode	-0.5	+7	V
$I_O$	output current	$0\text{ V} < V_O < V_{CC}$	-	$\pm 25$	mA
$I_{CC}$	supply current		-	+50	mA
$I_{GND}$	ground current		-50	-	mA
$T_{stg}$	storage temperature		-65	+150	°C
$P_{tot}$	total power dissipation	$T_{amb} = -40\text{ °C to }+85\text{ °C}$	-	500	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V <sub>CC</sub>	supply voltage		2.0	-	5.5	V
V <sub>I</sub>	input voltage		0	-	5.5	V
V <sub>O</sub>	output voltage		0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	-	+85	°C
Δt/ΔV	input transition rise and fall rate	V <sub>CC</sub> = 2.3 V to 2.7 V	0	-	200	ns/V
		V <sub>CC</sub> = 3.0 V to 3.6 V	0	-	100	ns/V
		V <sub>CC</sub> = 4.5 V to 5.5 V	0	-	20	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	T <sub>amb</sub> = -40 °C to +85 °C			Unit
			Min	Typ	Max	
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 2.0 V	1.5	-	-	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	0.7V <sub>CC</sub>	-	-	V
		V <sub>CC</sub> = 3.0 V to 3.6 V	0.7V <sub>CC</sub>	-	-	V
		V <sub>CC</sub> = 4.5 V to 5.5 V	0.7V <sub>CC</sub>	-	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 2.0 V	-	-	0.5	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.3V <sub>CC</sub>	V
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	-	0.3V <sub>CC</sub>	V
		V <sub>CC</sub> = 4.5 V to 5.5 V	-	-	0.3V <sub>CC</sub>	V
V <sub>OH</sub>	HIGH-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>				
		I <sub>O</sub> = -50 μA; V <sub>CC</sub> = 2.0 V to 5.5 V	V <sub>CC</sub> - 0.1	-	-	V
		I <sub>O</sub> = -2.0 mA; V <sub>CC</sub> = 2.3 V	2.0	-	-	V
		I <sub>O</sub> = -6.0 mA; V <sub>CC</sub> = 3.0 V	2.48	-	-	V
		I <sub>O</sub> = -12 mA; V <sub>CC</sub> = 4.5 V	3.8	-	-	V
V <sub>OL</sub>	LOW-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>				
		I <sub>O</sub> = 50 μA; V <sub>CC</sub> = 2.0 V to 5.5 V	-	-	0.10	V
		I <sub>O</sub> = 2.0 mA; V <sub>CC</sub> = 2.3 V	-	-	0.40	V
		I <sub>O</sub> = 6.0 mA; V <sub>CC</sub> = 3.0 V	-	-	0.44	V
		I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 4.5 V	-	-	0.55	V
I <sub>I</sub>	input leakage current	V <sub>I</sub> = V <sub>CC</sub> or GND; V <sub>CC</sub> = 5.5 V	-	±0.01	±1	μA
I <sub>OFF</sub>	power-off leakage current	V <sub>I</sub> or V <sub>O</sub> = 5.5 V; V <sub>CC</sub> = 0.0 V	-	±0.05	±5	μA
I <sub>CC</sub>	supply current	V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 5.5 V	-	0.2	20	μA
C <sub>I</sub>	input capacitance		-	3.0	-	pF

## 10. Dynamic characteristics

**Table 7. Dynamic characteristics**

GND (ground = 0 V); for test circuit, see [Fig. 11](#)

Symbol	Parameter	Conditions	T <sub>amb</sub> = -40 °C to +85 °C			Unit
			Min	Typ[1]	Max	
t <sub>pd</sub>	propagation delay	CE, CP to Q7, $\overline{Q7}$ ; C <sub>L</sub> = 15 pF; see <a href="#">Fig. 6</a> and <a href="#">Fig. 7</a> [2]				
		V <sub>CC</sub> = 2.3 V to 2.7 V [3]	1.0	11.0	22.0	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V [4]	1.0	7.5	18.0	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V [5]	1.0	5.5	11.5	ns
		$\overline{PL}$ to Q7, $\overline{Q7}$ ; C <sub>L</sub> = 15 pF; see <a href="#">Fig. 7</a>				
		V <sub>CC</sub> = 2.3 V to 2.7 V [3]	1.0	11.5	23.5	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V [4]	1.0	8.0	18.5	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V [5]	1.0	5.5	11.5	ns
		D7 to Q7, $\overline{Q7}$ ; C <sub>L</sub> = 15 pF; see <a href="#">Fig. 8</a>				
		V <sub>CC</sub> = 2.3 V to 2.7 V [3]	1.0	12.0	24.0	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V [4]	1.0	8.5	16.5	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V [5]	1.0	6.0	10.5	ns
		CE, CP to Q7, $\overline{Q7}$ ; see <a href="#">Fig. 6</a> and <a href="#">Fig. 7</a>				
		V <sub>CC</sub> = 2.3 V to 2.7 V [3]	1.0	13.0	26.0	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V [4]	1.0	9.0	21.5	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V [5]	1.0	6.1	13.5	ns
		$\overline{PL}$ to Q7, $\overline{Q7}$ ; see <a href="#">Fig. 7</a>				
		V <sub>CC</sub> = 2.3 V to 2.7 V [3]	1.0	14.0	28.0	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V [4]	1.0	10.0	22.0	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V [5]	1.0	6.5	13.5	ns
		D7 to Q7, $\overline{Q7}$ ; see <a href="#">Fig. 8</a>				
		V <sub>CC</sub> = 2.3 V to 2.7 V [3]	1.0	14.0	28.0	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V [4]	1.0	10.0	20	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V [5]	1.0	6.5	12.5	ns
t <sub>w</sub>	pulse width	CP input HIGH to LOW; see <a href="#">Fig. 6</a>				
		V <sub>CC</sub> = 2.3 V to 2.7 V [3]	9.0	-	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V [4]	7.0	-	-	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V [5]	4.0	-	-	ns
		$\overline{PL}$ input LOW; see <a href="#">Fig. 7</a>				
		V <sub>CC</sub> = 2.3 V to 2.7 V [3]	13.0	-	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V [4]	9.0	-	-	ns
t <sub>rec</sub>	recovery time	$\overline{PL}$ to CP, CE; see <a href="#">Fig. 7</a>				
		V <sub>CC</sub> = 2.3 V to 2.7 V [3]	8.5	-	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V [4]	6.0	-	-	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V [5]	4.0	-	-	ns

Symbol	Parameter	Conditions	T <sub>amb</sub> = -40 °C to +85 °C			Unit
			Min	Typ[1]	Max	
t <sub>su</sub>	set-up time	DS to CP, $\overline{\text{CE}}$ ; see Fig. 9				
		V <sub>CC</sub> = 2.3 V to 2.7 V [3]	6.0	-	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V [4]	4.0	-	-	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V [5]	7.0	-	-	ns
		$\overline{\text{CE}}$ to CP, CP to $\overline{\text{CE}}$ ; see Fig. 9				
		V <sub>CC</sub> = 2.3 V to 2.7 V [3]	7.0	-	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V [4]	5.0	-	-	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V [5]	3.5	-	-	ns
		D7 to PL; see Fig. 10				
		V <sub>CC</sub> = 2.3 V to 2.7 V [3]	12	-	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V [4]	8.5	-	-	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V [5]	5.0	-	-	ns
t <sub>h</sub>	hold time	DS to CP, $\overline{\text{CE}}$ ; PL to CP, $\overline{\text{CE}}$ ; see Fig. 9				
		V <sub>CC</sub> = 2.3 V to 2.7 V [3]	0	-	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V [4]	0	-	-	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V [5]	0.5	-	-	ns
		Dn to PL; see Fig. 10				
		V <sub>CC</sub> = 2.3 V to 2.7 V [3]	0.5	-	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V [4]	0.5	-	-	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V [5]	1.0	-	-	ns
f <sub>max</sub>	maximum frequency	CP input; C <sub>L</sub> = 15 pF; see Fig. 6				
		V <sub>CC</sub> = 2.3 V to 2.7 V [3]	45	80	-	MHz
		V <sub>CC</sub> = 3.0 V to 3.6 V [4]	50	115	-	MHz
		V <sub>CC</sub> = 4.5 V to 5.5 V [5]	90	165	-	MHz
		CP input; see Fig. 6				
		V <sub>CC</sub> = 2.3 V to 2.7 V [3]	35	65	-	MHz
		V <sub>CC</sub> = 3.0 V to 3.6 V [4]	50	90	-	MHz
		V <sub>CC</sub> = 4.5 V to 5.5 V [5]	85	125	-	MHz
C <sub>PD</sub>	power dissipation capacitance	V <sub>I</sub> = GND to V <sub>CC</sub> ; V <sub>CC</sub> = 3.3 V [6]	-	24	-	pF

[1] Typical values are measured at T<sub>amb</sub> = 25 °C and nominal V<sub>CC</sub>.

[2] t<sub>pd</sub> is the same as t<sub>PHL</sub> and t<sub>PLH</sub>.

[3] Typical values are measured at V<sub>CC</sub> = 2.5 V.

[4] Typical values are measured at V<sub>CC</sub> = 3.3 V.

[5] Typical values are measured at V<sub>CC</sub> = 5.0 V.

[6] C<sub>PD</sub> is used to determine the dynamic power dissipation P<sub>D</sub> = C<sub>PD</sub> × V<sub>CC</sub><sup>2</sup> × f<sub>i</sub> + Σ(C<sub>L</sub> × V<sub>CC</sub><sup>2</sup> × f<sub>o</sub>) (P<sub>D</sub> in μW), where:

f<sub>i</sub> = input frequency in MHz;

f<sub>o</sub> = output frequency in MHz;

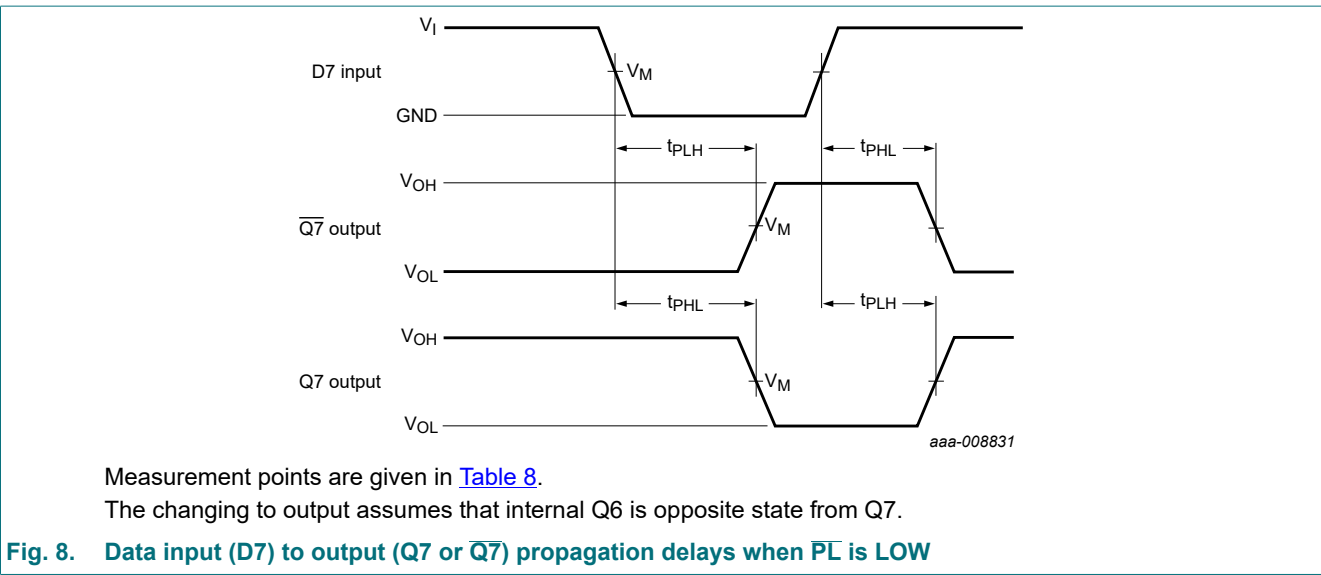
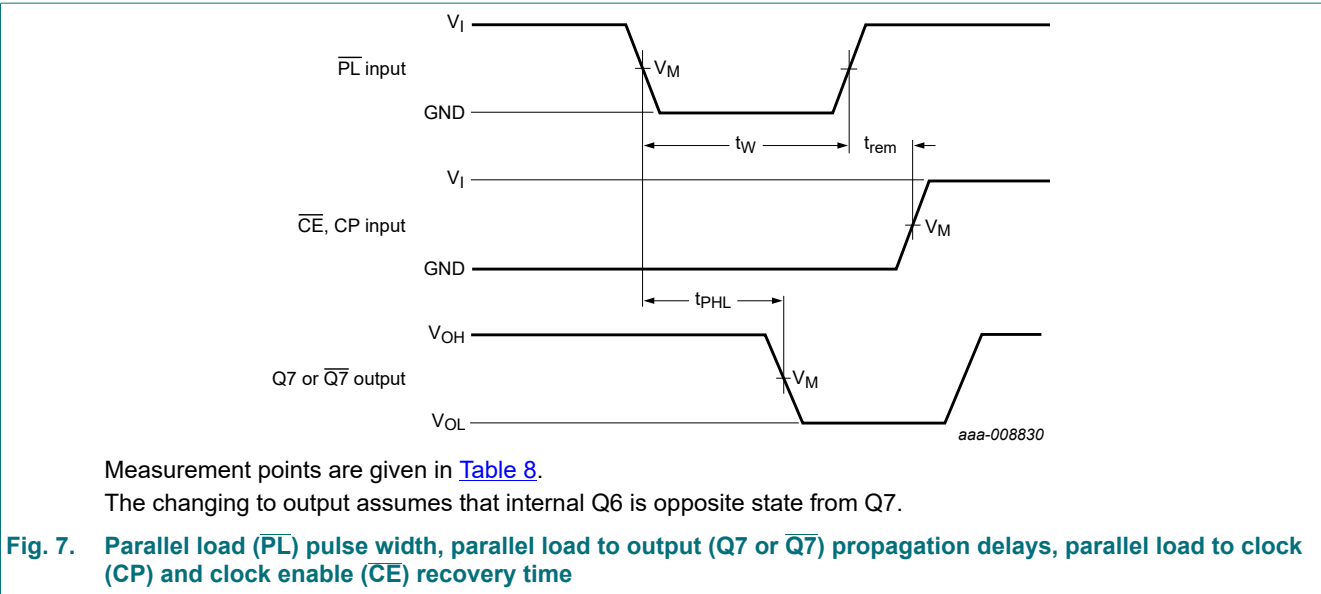
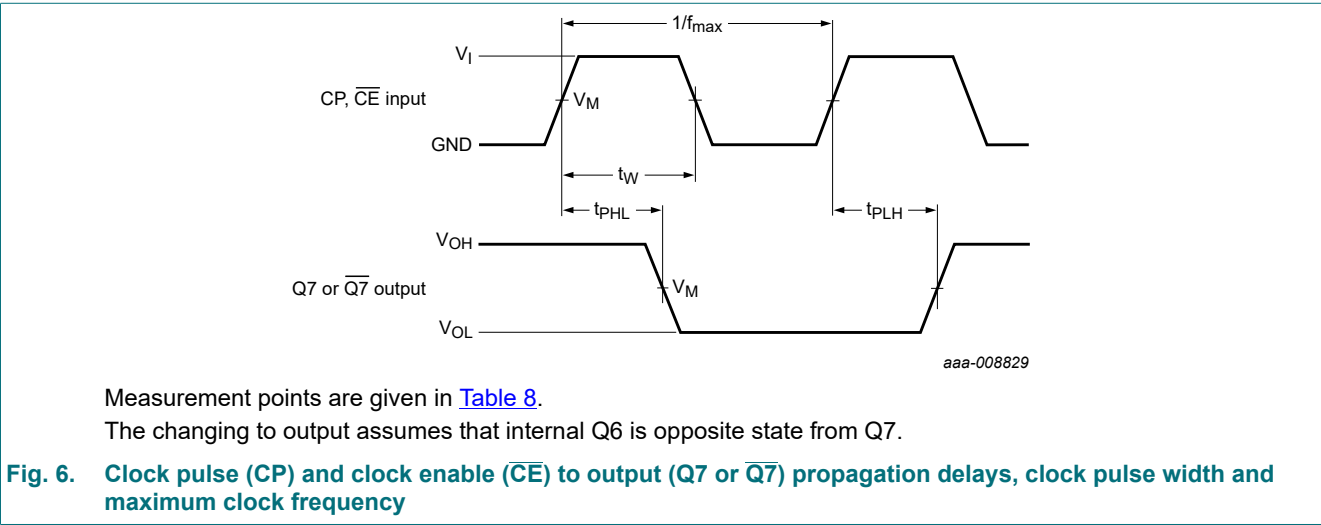
Σ(C<sub>L</sub> × V<sub>CC</sub><sup>2</sup> × f<sub>o</sub>) = sum of outputs;

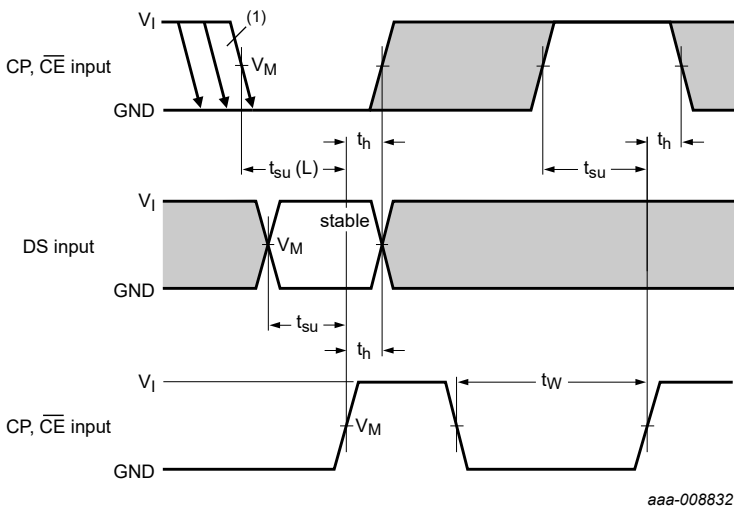
C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V.



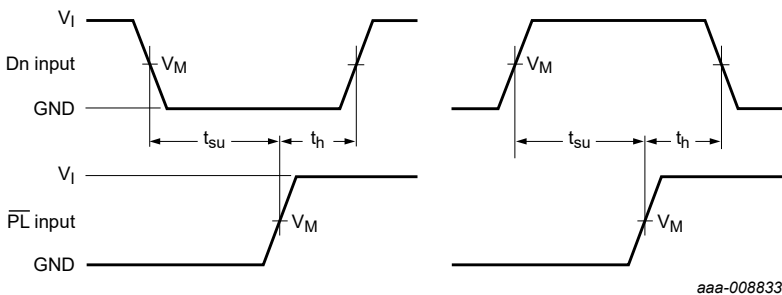
10.1. Waveforms and test circuit





Measurement points are given in [Table 8](#).  
(1) CE may change only from HIGH-to-LOW while CP is LOW.  
The shaded areas indicate when the input is permitted to change for predictable output performance.

Fig. 9. Set-up and hold times

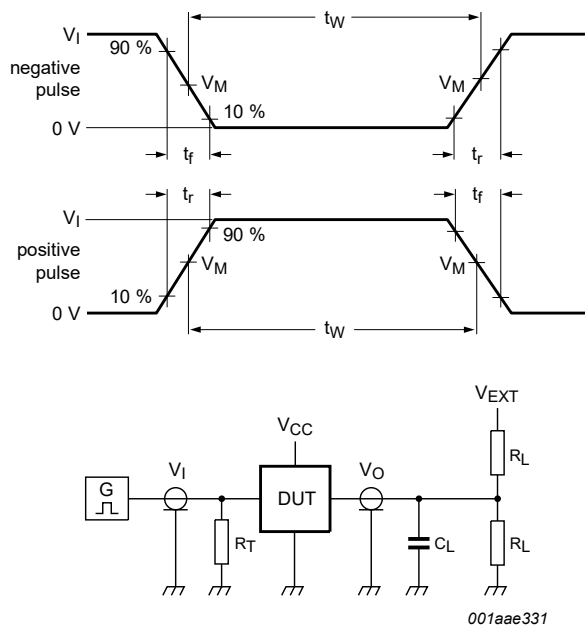


Measurement points are given in [Table 8](#).

Fig. 10. Set-up and hold times from the data inputs (Dn) to the parallel load input ( $\overline{PL}$ )

Table 8. Measurement points

Supply voltage	Input	Output
$V_{CC}$	$V_M$	$V_M$
2.0 V to 5.5 V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$



Test data is given in [Table 9](#).  
Definitions for test circuit:  
 $R_L$  = Load resistance;  
 $C_L$  = Load capacitance including jig and probe capacitance;  
 $R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator;  
 $V_{EXT}$  = External voltage for measuring switching times.

Fig. 11. Test circuit for measuring switching times

Table 9. Test data

Supply voltage	Input		Load		$V_{EXT}$
	$V_I$	$t_r, t_f$	$C_L$	$R_L$	$t_{PHL}, t_{PLH}$
2.0 V to 5.5 V	$V_{CC}$	3.0 ns	50 pF, 15 pF	1 kΩ	open

11. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1

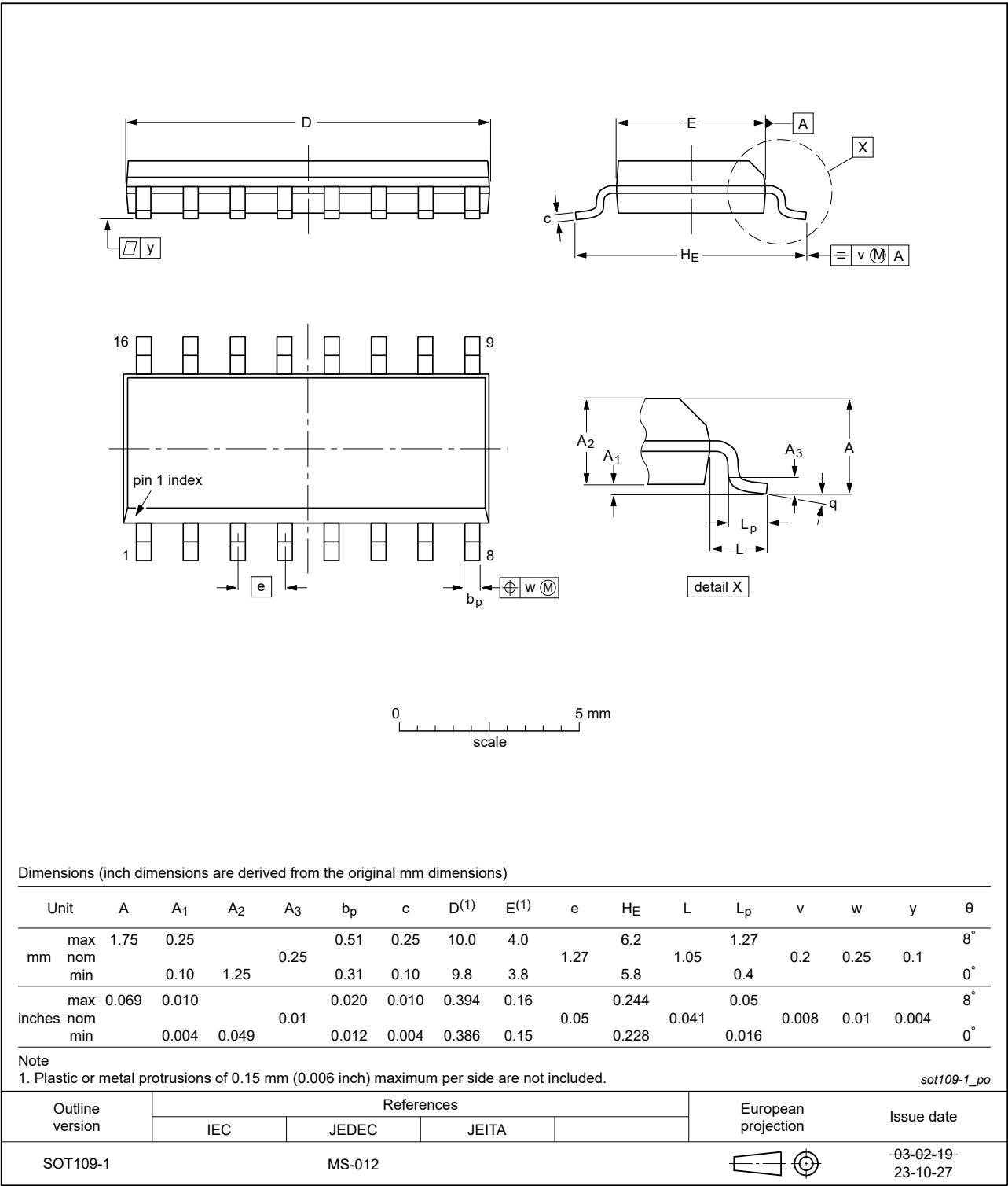


Fig. 12. Package outline SOT109-1 (SO16)

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1

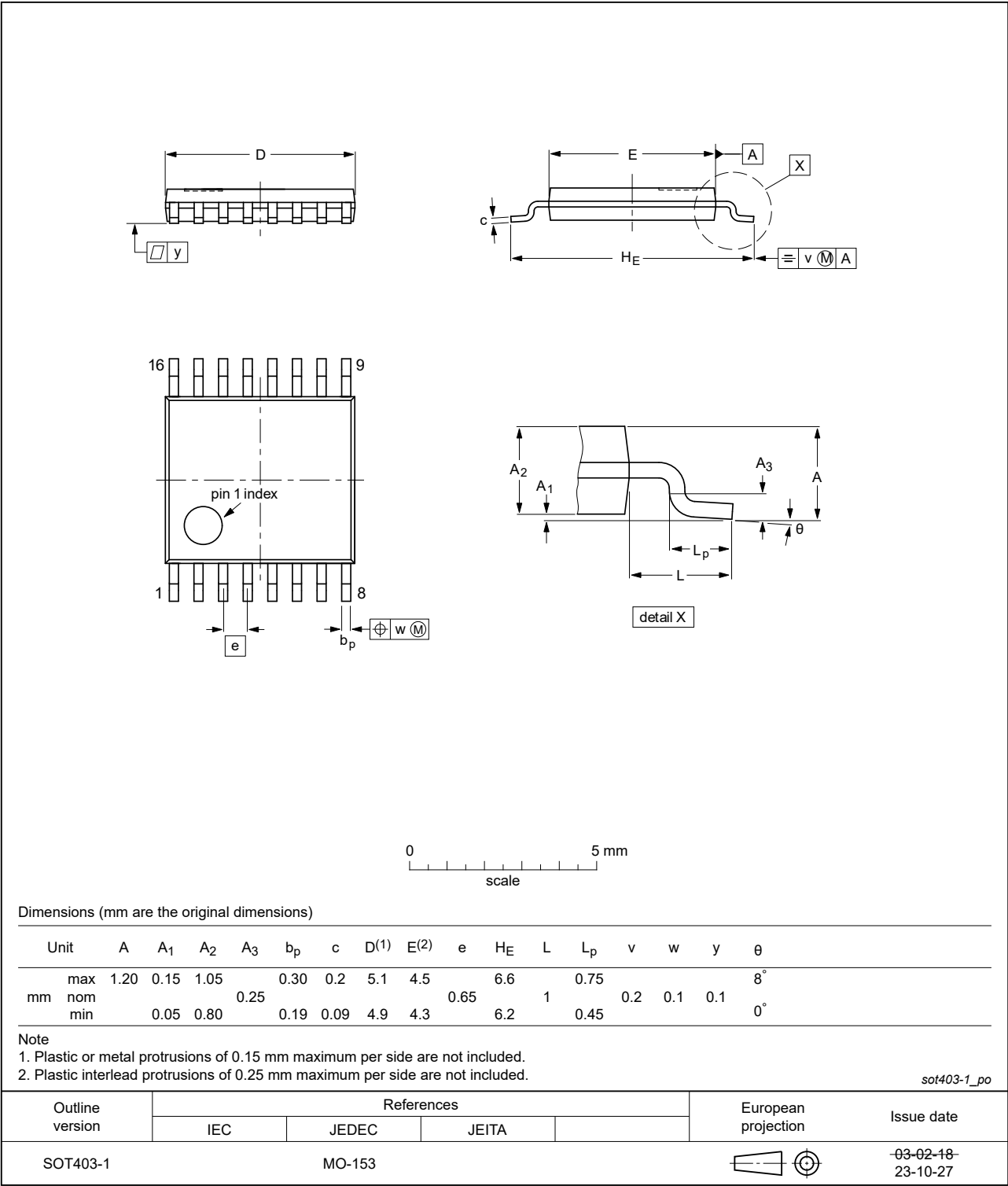


Fig. 13. Package outline SOT403-1 (TSSOP16)

12. Abbreviations

Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
TTL	Transistor-Transistor Logic

13. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LV165A_Q100 v.4	20240418	Product data sheet	-	74LV165A_Q100 v.3
Modifications:	<ul style="list-style-type: none"><li>Section 2: ESD specification updated according to the latest JEDEC standard.</li><li>Fig. 12, Fig. 13: Aligned SO and TSSOP package outline drawings to JEDEC MS-012 and MO-153</li></ul>			
74LV165A_Q100 v.3	20140328	Product data sheet	-	74LV165A_Q100 v.2
Modifications:	<ul style="list-style-type: none"><li>Minimum limit <math>V_{OH}</math> for <math>V_{CC} = 4.5\text{ V}</math> corrected from 3.0 V to 3.8 V (errata) in Table 6</li></ul>			
74LV165A_Q100 v.2	20140219	Product data sheet	-	74LV165A_Q100 v.1
Modifications:	<ul style="list-style-type: none"><li>Typo corrected in Table 2</li></ul>			
74LV165A_Q100 v.1	20131021	Product data sheet	-	-

## 14. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <https://www.nexperia.com>.

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